SiB441EDK

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Vishay Siliconix

RoHS

COMPLIANT

HALOGEN

FREE





Bottom View

Top View Marking code: BO

1.6 m

PRODUCT SUMMARY	
V _{DS} (V)	-12
$R_{DS(on)}$ max. (Ω) at V_{GS} = -4.5 V	0.0255
$R_{DS(on)}$ max. (Ω) at V_{GS} = -3.7 V	0.0280
$R_{DS(on)}$ max. (Ω) at V_{GS} = -2.5 V	0.0360
$R_{DS(on)}$ max. (Ω) at V_{GS} = -1.8 V	0.0600
$R_{DS(on)}$ max. (Ω) at V_{GS} = -1.5 V	0.1150
Q _g typ. (nC)	13.4
I _D (A) ^a	9
Configuration	Single

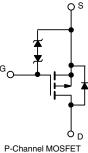
FEATURES

P-Channel 12 V (D-S) MOSFET

- TrenchFET[®] power MOSFET
- Thermally enhanced PowerPAK® SC-75 package
 - Small footprint area
 - Low on-resistance
- Typical ESD performance 2500 V
- 100 % R_q tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Portable devices such as smart phones, tablet PCs, and mobile computing
 - Battery switch
- Load switch
- Power management



Package	PowerPAK SC-75
Lead (Pb)-free and halogen-free	SiB441EDK-T1-GE3

ABSOLUTE MAXIMUM RATINGS (T	_A = 25 °C, unless	s otherwise no	ted)	
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V _{DS}	-12	v
Gate-source voltage		V _{GS}	± 8	v
	T _C = 25 °C		-9 a	
Continuous drain aurrant (T 150 °C)	T _C = 70 °C		-9 a	
Continuous drain current ($T_J = 150 \ ^{\circ}C$)	T _A = 25 °C	I _D	-8.3 ^{b, c}	
	T _A = 70 °C		-6.6 ^{b, c}	А
Pulsed drain current (t = 300 µs)		I _{DM}	-40	
Continuous source-drain diode current	T _C = 25 °C	1	-9 ^a	
Continuous source-drain diode current	T _A = 25 °C	I _S	-2 ^{b, c}	
	T _C = 25 °C		13	
Maximum power dissipation	T _C = 70 °C	PD	8.4	w
Maximum power dissipation	T _A = 25 °C	FD	2.4 ^{b, c}	vv
	T _A = 70 °C		1.6 ^{b, c}	
Operating junction and storage temperature rang	e	T _J , T _{stg}	-55 to +150	°C
Soldering recommendations (peak temperature)	d, e		260	

THERMAL RESISTANCE RATINGS									
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT				
Maximum junction-to-ambient ^{b, f}	t ≤ 5 s	R _{thJA}	41	51	°C/W				
Maximum junction-to-case (drain)	Steady state	R _{thJC}	7.5	9.5	C/W				

Notes a. Package limited

b. Surface mounted on 1" x 1" FR4 board

t = 5 s c.

See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SC-75 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection d.

Rework conditions: manual soldering with a soldering iron is not recommended for leadless components Maximum under steady state conditions is 105 °C/W e. f.

S13-0197-Rev. A, 28-Jan-13

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Document Number: 62821

For technical questions, contact: pmostechsupport@vishay.com

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SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$,		i wise noted)	-						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT			
Static									
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 V, I_D = -250 \ \mu A$	-12	-	-	V			
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	L 050		-5	-	mV/°C			
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = -250 μA	-	2.7	-				
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	-0.4	-	-0.9	V			
Gate-source leakage	1	V_{DS} = 0 V, V_{GS} = ± 8 V	-	-	± 4				
Gale-source leakage	I _{GSS}	V_{DS} = 0 V, V_{GS} = ± 4.5 V	-	-	± 1				
Zero gate voltage drain current	lana	$V_{DS} = -12 V, V_{GS} = 0 V$	-	-	-1	μA			
Zero gate voltage drain current	I _{DSS}	V_{DS} = -12 V, V_{GS} = 0 V, T_{J} = 55 °C	-	-	-10				
On-state drain current ^a	I _{D(on)}	$V_{DS} \leq$ -5 V, V_{GS} = -4.5 V	-15	-	-	А			
		$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -4 \text{ A}$	-	0.0210	0.0255	5			
		$V_{GS} = -3.7 \text{ V}, I_D = -4 \text{ A}$	-	0.0230	0.0280				
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = -2.5 \text{ V}, \text{ I}_{D} = -2 \text{ A}$	-	0.0290	0.0360	Ω			
		$V_{GS} = -1.8 \text{ V}, I_D = -2 \text{ A}$	-	0.0420	0.0600				
		V_{GS} = -1.5 V, I _D = -0.5 A	-	0.0570	0.1150				
Forward transconductance a	g fs	$V_{DS} = -6 V, I_D = -4 A$	-	17	-	S			
Dynamic ^b									
Input capacitance	C _{iss}		-	1180	-				
Output capacitance	Coss	V_{DS} = -6 V, V_{GS} = 0 V, f = 1 MHz	-	265	-	pF			
Reverse transfer capacitance	C _{rss}		-	250	-				
Tatal asta sharra	0	$V_{DS} = -6 V, V_{GS} = -8 V, I_D = -2.1 A$	-	22.1	33				
Total gate charge	Qg		-	13.4	20				
Gate-source charge	Q _{gs}	V_{DS} = -6 V, V_{GS} = -4.5 V, I_D = -2.1 A	-	1.6	-	nC			
Gate-drain charge	Q _{gd}		-	3.4	-				
Gate resistance	Rg	f = 1 MHz	2.2	11	22	Ω			
Turn-on delay time	t _{d(on)}		-	22	45				
Rise time	t _r	V_{DD} = -6 V, R_L = 2.7 Ω	-	42	85	-			
Turn-off delay time	t _{d(off)}	$I_D \cong$ -2.2 A, V_{GEN} = -4.5 V, R_g = 1 Ω	-	60	120				
Fall time	t _f		-	50	100				
Turn-on delay time	t _{d(on)}		-	7	15	ns			
Rise time	tr	V_{DD} = -6 V, R_L = 2.7 Ω	-	10	20	1			
Turn-off delay time			-	60	120				
Fall time	t _f		-	52	100	1			
Drain-Source Body Diode Characterist	ics								
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	-9				
Pulse diode forward current	I _{SM}		-	-	-40	A			
Body diode voltage	V _{SD}	I _S = -2.2 A, V _{GS} = 0 V	-	-0.85	-1.2	V			
Body diode reverse recovery time	t _{rr}		-	30	60	ns			
Body diode reverse recovery charge	Q _{rr}	I _F = -2.2 A, di/dt = 100 A/μs,	-	12	25	nC			
Reverse recovery fall time	t _a	$T_{\rm J} = 25 ^{\circ}{\rm C}$	-	9	-				
Reverse recovery rise time	t _b		-	11	-	ns			

Notes

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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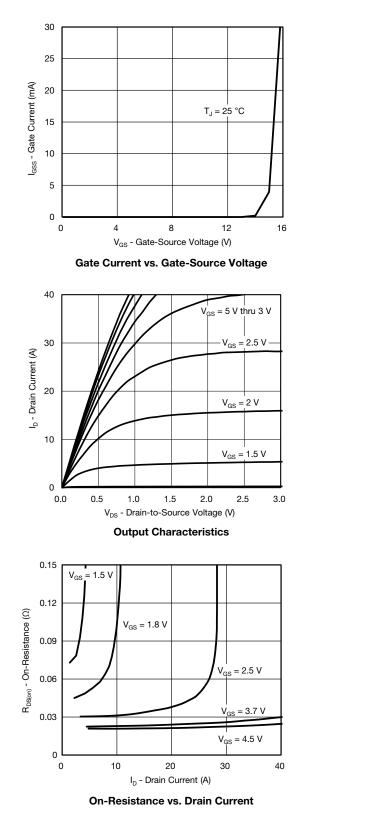
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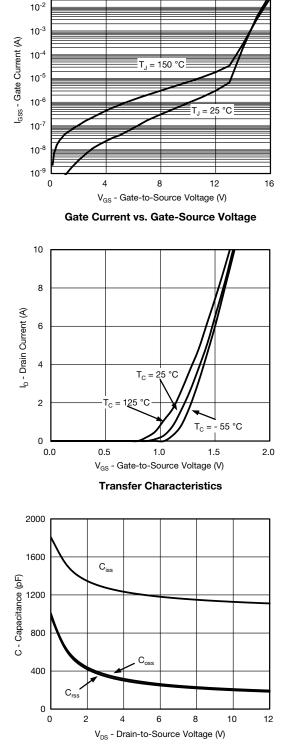


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





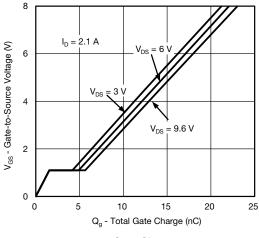
10⁻¹

Capacitance

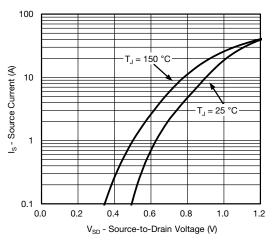


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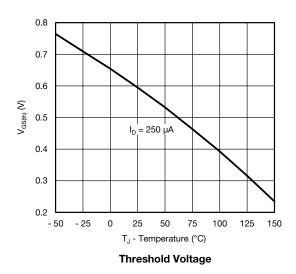
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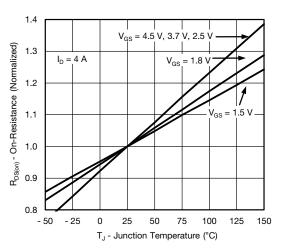




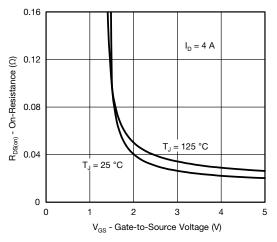


Source-Drain Diode Forward Voltage

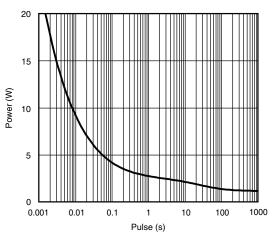




On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient

4

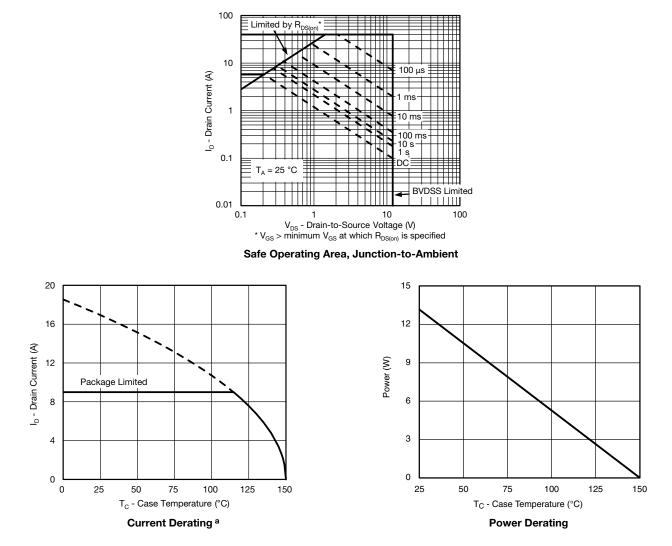
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



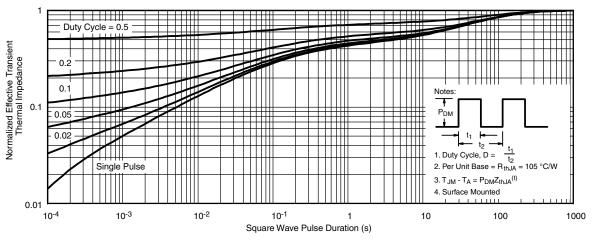
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

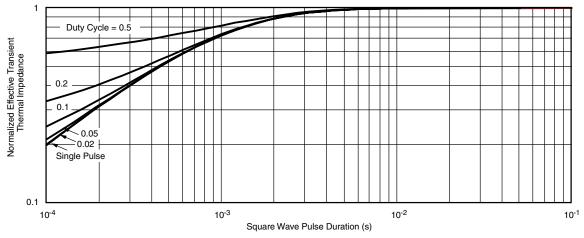


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient

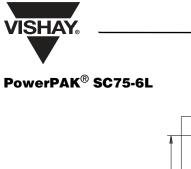


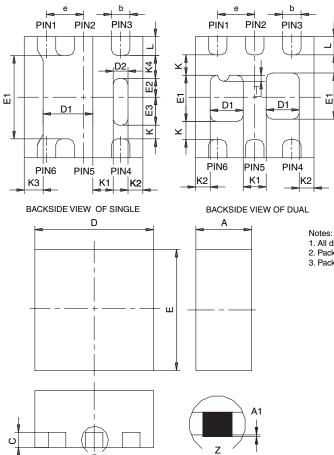
Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg?62821</u>.

Package Information

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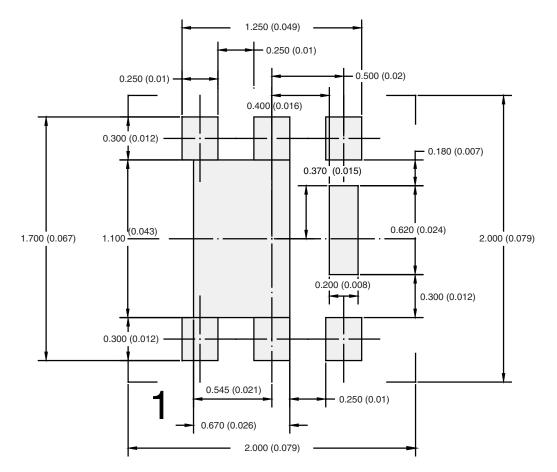
All dimensions are in millimeters
Package outline exclusive of mold flash and metal burr
Package outline inclusive of plating

DETAIL Z

	SINGLE PAD						DUAL PAD					
DIM	М	ILLIMETER	RS		INCHES		MILLIMETERS			INCHES		
	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max
Α	0.675	0.75	0.80	0.027	0.030	0.032	0.675	0.75	0.80	0.027	0.030	0.032
A1	0	-	0.05	0	-	0.002	0	-	0.05	0	-	0.002
b	0.18	0.25	0.33	0.007	0.010	0.013	0.18	0.25	0.33	0.007	0.010	0.013
С	0.15	0.20	0.25	0.006	0.008	0.010	0.15	0.20	0.25	0.006	0.008	0.010
D	1.53	1.60	1.70	0.060	0.063	0.067	1.53	1.60	1.70	0.060	0.063	0.067
D1	0.57	0.67	0.77	0.022	0.026	0.030	0.34	0.44	0.54	0.013	0.017	0.021
D2	0.10	0.20	0.30	0.004	0.008	0.012						
Е	1.53	1.60	1.70	0.060	0.063	0.067	1.53	1.60	1.70	0.060	0.063	0.067
E1	1.00	1.10	1.20	0.039	0.043	0.047	0.51	0.61	0.71	0.020	0.024	0.028
E2	0.20	0.25	0.30	0.008	0.010	0.012						
E3	0.32	0.37	0.42	0.013	0.015	0.017						
е		0.50 BSC		0.020 BSC			0.50 BSC			0.020 BSC		
К		0.180 TYP)	0.007 TYP			0.245 TYP			0.010 TYP		
K1		0.275 TYP)	0.011 TYP			0.320 TYP			0.013 TYP		
K2		0.200 TYP)	0.008 TYP		0.200 BSC			0.008 TYP			
K3		0.255 TYP)	0.010 TYP								
K4		0.300 TYP)	0.012 TYP								
L	0.15	0.25	0.35	0.006	0.010	0.014	0.15	0.25	0.35	0.006	0.010	0.014
Т							0.03	0.08	0.13	0.001	0.003	0.005



RECOMMENDED PAD LAYOUT FOR PowerPAK[®] SC75-6L Single



Dimensions in mm/(Inches)

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